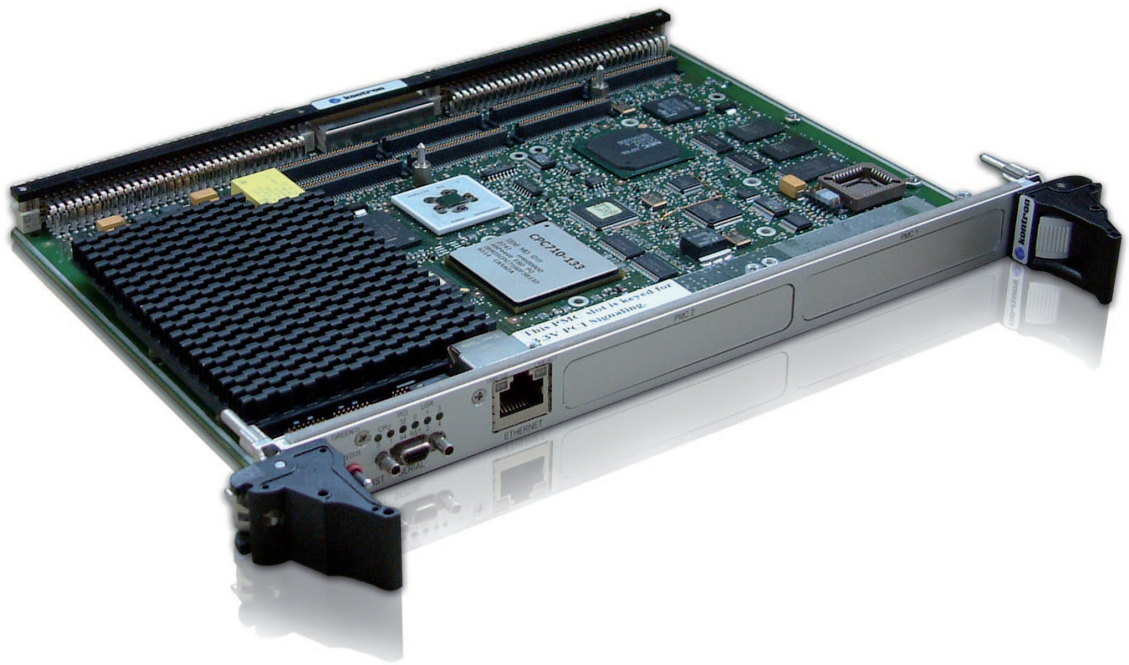
kontron

» PowerNode3+ «



Low Power Dual 1.4 GHz MPC7448 VME Board

» Outstanding Computing Performance and Improved Connectivity

» 1 MB Internal L2 Cache Clocked at Processor Frequency

» VME 2eSST (150 MB/s) Capability

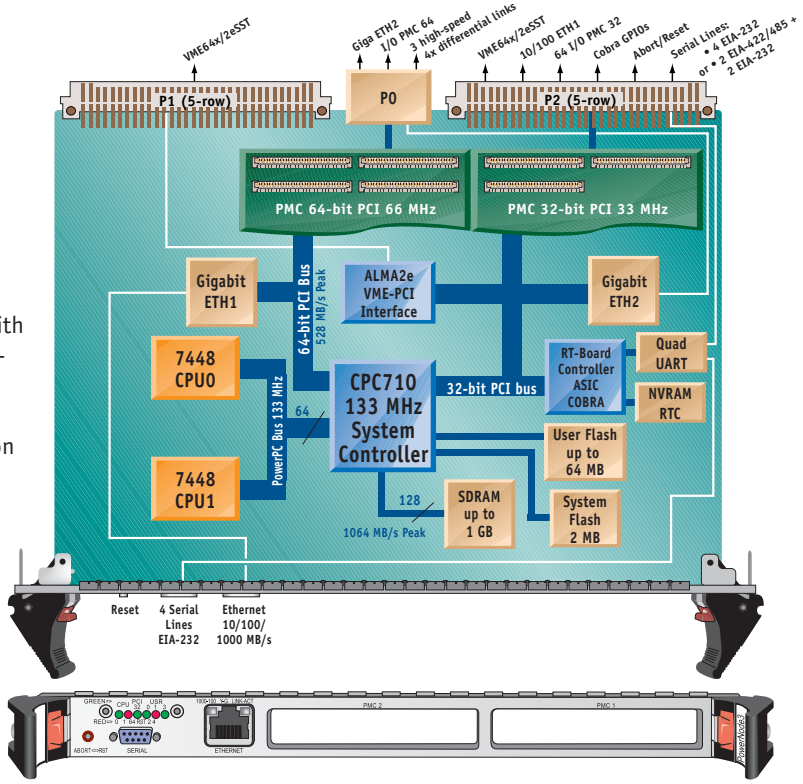
» Air and Conduction-Cooled Releases

PowerNode3+

Low Power Dual 1.4 GHz MPC7448 VME Board

The PowerNode3+ is a confirmation of Kontron's technological excellence.

With its AltiVec vector processing unit, the PowerPC 7448 (G4+) is ideally suited for Signal Processing functions and leading-edge computing. It combines outstanding and unprecedented performance level with low power dissipation. In addition, the PowerNode3+ meets Kontron's technology insertion policy which offers customers a clear performance upgrade path while protecting long-term investments in application software.



PowerPC G4+ 7448: Outstanding Performance for Demanding Signal Processing Application

The PowerNode3+ features the PowerPC G4+ 7448 from Freescale, delivering 1.4 GHz performance with less than 12W.

Manufactured using Freescale's Silicon-On-Insulator (SOI) process technology, the MPC7448 represents an optimal high-performance choice for power dissipationsensitive applications.

AVIGNON High-Performance Host Bridge

AVIGNON, the host bridge (part number CPC710), benefits from the accumulated experience of both partners since the beginning of the PowerPC. It performs as a crossbar between the processors, the main memory, and the PCI busses. This crossbar function is a key to implementing a high-performance computing node.

ALMA2e Low Power VME Bridge

ALMA2e is the PCI/VMEbus bridge that interfaces the PCI bus of Avignon with the VME 2eSST and/or VME64 bus with an outstanding sustained performance of 150 MB/s. Furthermore, due to its small die size, ALMA2e surpasses the competition for low power designs.

COBRA Real-Time Board Controller

COBRA is dedicated to the control of interrupts and other realtime functions. The interrupt controller features an OpenPIC compliant device including multiprocessor support.

Leading Edge Architecture

Memory: The PowerNode3+ features a unique memory architecture with the highest available bandwidth. In a dual G4+ architecture, the highest possible bandwidth from the memory sub-system is needed to constantly and efficiently feed the multiple Altivec engines in every PowerPC G4+.

The symmetrical topology of the PowerNode3+ memory subsystem offers the highest bandwidth and latency capabilities required when processing large amounts of data simultaneously from both G4+s. Acquisition can be performed directly into a shareable area of the main memory, and each G4+ can immediately start to work concurrently on the data set without any unnecessary buffer copies. This is by far the lowest possible latency for critical complex algorithms such as distributed and collaborative signal processing applications (e.g. beam forming).

I/O: Two PCI busses allow Avignon to manage two data flows concurrently. Combined with high-performance networking PMCs, it allows versatile configurations to meet the various requirements of complex data-flow architectures.

Software Offering

With the increased computing power and the versatility of the PowerPC G4+, it is now possible to use COTS hardware and software to build innovative solutions to handle signal processing applications such as sonar, radar and medical imaging. But brute force number crunching is not enough to deliver a complete working system with dozens of VME G4+ boards and associated PMC I/O links. To lower the time-tomarket for such complex systems, Kontron designed PowerLine, a set of tools that covers key areas: low-level message passing with DDlink VI and a full machine supervisor in the system.

VSIPL Signal Processing Library

The VSIPL Signal Processing Library is becoming the de facto standard library allowing portability across different brands of platforms.

Kontron has optimized such a library, called VSI/Pro®, on the PowerPC 7410 and 7448 processors. VSI/Pro enables developers to easily map complex algorithms onto multiprocessor architectures and fully optimize the AltiVec vector unit of the PowerPC 7448.

Single-Source Customer Service

Leveraging more than 20 years of new product development and customer support in embedded and rugged computers, Kontron offers a wide range of integration and maintenance services, from product warranty and start-up assistance to the delivery of fully tested preintegrated systems and one-stop shop delivery of qualified racks and PMCs.

Product Warranty and Services

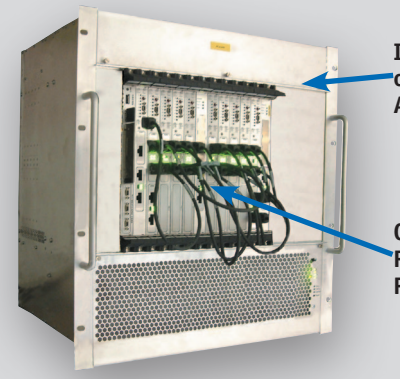
All of Kontron´s hardware products are covered by a two-year return-to-factory warranty.

Several service programs are available, including update services, hotline access, product repair and exchange services, technical assistance, on-site or remote technical assistance.

ISO 9001: Kontron´s ISO 9001 certification is just another way for us to back our commitment to quality products and customer service.

Finally, in addition to its standard support services, Kontron offers customized consultation to system integrators.

Full Pre-Integrated System



Technical Information

System processor and Chipset	
Processor	One or two superscalar PowerPC 7448 processors operating from 1 GHz to 1.4 GHz
Cache Structure	L1: 32 KB instruction cache and 32 KB data cache per processor L2: 1 MB clocked at full CPU speed
MIPS	12 FFT GFlops
Altivec™ vector unit	
Memory	
Global Memory	512 MB or 1 GB onboard SDRAM with ECC
User Flash	Up to 64 MB of contiguous directly accessible, 32-bit wide flash memory for OS and application code
System Flash	2 MB Flash Device
Onboard Controllers	ALMA2e VME-PCI Interface CP710 System Controller Host Bridge COBRA Real-Time I/O Controller
VME Interface	ALMA2e V64 and 2eSST VME/PCI bridge with semaphore registers A32/A24/A16 master slave D64 (MBLT)/D32 (BLT)/D16/D08 master/slave 5-row connectors
PCI Interface	PMC 1: PCI R2 compliant (32 bits) 5V and 3.3V signaling, 1 PMC slot, 33 MHz PCI frequency (44 MHz option available), DMA engine: DRAM <=> PCI PMC 2: PCI R2 compliant (32/64 bits) 3.3V signaling, 1 PMC slot (up to 3 with carrier card), 33 or 66 MHz PCI frequency, DMA engine: DRAM <=> PCI
Real-Time I/O	
Interrupt Controller	32 I/O device interrupt inputs, and 4 interprocessor interrupts
Real-Time Controller	connection to PCI bus Rev. 2, ISA-like interface for serial ports, large non-volatile memory interface (NVRAM, Flash, ...), optimized message passing with four high-density FIFOs, GPIOs, four highly programmable 32-bit global timers
Rear I/O via P0&P2	
Serial Ports	Four simplified (Rx, Tx) EIA-232 ports or two simplified (Rx,Tx) EIA-422/EIA-485 ports on P2
Ethernet	One 10/100/1000BASE-T Ethernet port (build option on P2)
General Purpose I/Os	Four GPIO on P2
PMC I/Os	64 PCI 32 on P2 - 64 PCI 64 on P0 or three differential x4 high-speed links on P0, following PICMG 2.17/2.18
Extension	
Rear Transition Module	VME64 I/O CP2IOS2BC (rear I/O via P2) - VME64 I/O PBV36-P0-CN300-00 (rear I/O via P0&P2)
Front Panel Interface	
Serial Ports	Four simplified (Rx, Tx) EIA-232 ports
Ethernet	One 10/100/1000BASE-T Ethernet port (build option) on P2 - One 10/100/1000BASE-T Ethernet port on P0
Software	Power-on Built-In Test, and Initiated Built-In Test testing over 95% of board features BSPs available for LynxOS, Linux Fedora Core 3 and VxWorks RTOS

Technical Information

Power @ 1.4 GHz	Dual
Maximum Power Requirement	57 W
Typical Power Requirement at Firmware Prompt	44 W
Typical Power Requirement at OS Prompt	35 W
Miscellaneous	
Debug	Extra connectors interface ICE/JTAG tools to any of the two processors
Weight	Standard Air-Cooled: 490g approx. - Rugged Conduction-Cooled: 830g approx.
Build Options	Standard Air-Cooled (SA) or Rugged Conduction-Cooled (RC) Releases SDRAM: 512 MB, 1024 MB Flash: No Flash, 32 MB, 64 MB PMC 32 slot VIO Key (PCI signaling voltage): 5V or 3.3V First Ethernet Link (ETH1): Front panel or routed to backplane

Environmental Specifications

	SA - Standard Commercial	RC - Rugged Conduction-Cooled
Conformal Coating	Optional	Standard
Airflow	1.8 m/s	NA
Temperature	VITA 47-Class AC1	VITA 47-Class CC4
Cooling Method	Convection	Conduction
Operating	0° to +55°C	-40° to +85°C
Storage	-45° to +85°C	-45° to +100°C
Vibration Sine (Operating)	20-500 Hz - 2g	20-2,000 Hz - 5g
Random	VITA 47-Class V1	VITA 47-Class V3
Shock (Operating)	20g/11 ms Half Sine	40g/20 ms Half Sine
Altitude (Operating)	-1,640 to 15,000 ft	-1,640 to 50,000 ft
Relative Humidity	90% without condensation	95% without condensation

Ordering Information

Article	Part.- No	Description
Standard Air Cooled (SA Class)		Two PowerPC 7448 / 1400 MHz CPU /133 MHz FSB
PowerNode3+	VEGB2SAB03100000	512 MB SDRAM / 32 MB Flash / PMC32 VIO set for 5V signalling PMCs / Front Panel Ethernet
PowerNode3+	VEGB2SAB03010000	512 MB SDRAM / No Flash / PMC32 VIO set for 3.3V signalling PMCs /Front Panel Ethernet
PowerNode3+	VEGB2SAB04010000	1024 MB SDRAM / No Flash / PMC32 VIO set for 3.3V signalling PMCs /Front Panel Ethernet
PowerNode3+	VEGB2SAB04211000	1024 MB SDRAM / 64 MB Flash / PMC32 VIO set for 3.3V signalling PMCs /Ethernet routed to backplane
PowerNode3+	VEGB2SAB03200000	512 MB SDRAM / 64 MB Flash / PMC32 VIO set for 5V signalling PMCs / Front Panel Ethernet
PowerNode3+	VEGB2SAB03210000	512 MB SDRAM / 64 MB Flash / PMC32 VIO set for 3.3V signalling PMCs / Front Panel Ethernet
Rugged Conduction-Cooled (RC Class)		Two PowerPC 7448 / 1000 MHz CPU / 100 MHz FSB
PowerNode3+	VEGB2RCA03201000	512 MB SDRAM / 64 MB Flash / PMC32 VIO set for 5V signalling PMCs /Ethernet routed to backplane
PowerNode3+	VEGB2RCA03001000	512 MB SDRAM / No Flash / PMC32 VIO set for 5V signalling PMCs /Ethernet routed to backplane

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